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TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE

# 2SK3075

#### RF POWER MOSFET FOR VHF-AND UHF-BAND POWER AMPLIFIER

- Output Power  $: P_O \ge 7.5 W$
- Power Gain  $: G_P \ge 11.7 dB$
- Drain Efficiency  $: \eta_D \ge 50\%$

## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V <sub>DSS</sub>	30	V
Gate-Source Voltage	V <sub>GSS</sub>	25	V
Drain Current	I <sub>D</sub>	5	А
Drain Power Dissipation	P <sub>D*</sub>	20	W
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature Range	T <sub>stg</sub>	-45~150	°C

\*: Tc = 25°C When mounted on a 1.6mm glass epoxy PCB

#### MARKING



-		Unit. mm			
(3±02 -01 -01 -01 -01 -02 -01 -02 -01	¢1.2±0.2 0.6±0.2 0.6±0.2 0.5±0.1 1.5±0.1 1.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.1 0.5±0.2 0.				
200 + 200	1. GATE 2. SOURCE (HEAT SINK) 3. DRAIN				
JEDEC					
EIAJ					
TOSHIB	A 2-8	5N1A			

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# ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Power	PO	V <sub>DS</sub> = 9.6V lidle = 50mA (V <sub>GS</sub> = adjust) f = 520MHz, P <sub>i</sub> = 500mW	7.5	_	_	W
Drain Efficiency	η <sub>D</sub>		50	-	_	%
Power Gain	GP	$Z_G = Z_L = 50\Omega$	11.7		_	dB
Gate Threshold Voltage	V <sub>th</sub>	V <sub>DS</sub> = 9.6V, I <sub>D</sub> = 0.5mA	1.0	1.5	2.0	V
Drain Cut-off Current	I <sub>DSS</sub>	$V_{DS}$ = 20V, $V_{GS}$ = 0	_	_	10	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0	_		5	μA

## HANDLING PRECAUTION

• When handling individual devices, be sure that working desks, human bodies and soldering iron are protected against electrostatic electricity.

## **RF OUTPUT POWER TEST FIXTURE**





# CAUTION

These are only typical curves and devices are not necessarily guaranteed at these curves.

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.